Docket No.: MAS-FIN-193

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**Applicant** 

HARRY HEDLER ET AL.

Filed

CONCURRENTLY HEREWITH

Title

ELECTRONIC COMPONENT WITH FLEXIBLE BONDING PADS AND

METHOD OF PRODUCING A COMPONENT

## INFORMATION DISCLOSURE STATEMENT

Hon. Commissioner of Patents and Trademarks, Washington, D.C. 20231

Sir:

In accordance with 37 C.F.R. 1.98 copies of the following patents and/or publications are submitted herewith:

U.S. Patent 5,508,228 (Nolan et al.), dated April 16, 1996;

U.S. Patent 5,685,885 (Khandros et al.), dated November 11, 1997;

U.S. Patent 5,874,782 (Palagonia), dated February 23, 1999;

U.S. Patent 6,319,564 B1 (Naundorf et al.), dated November 20, 2001;

PCT WO 98/52225 (Young et al.), dated November 19, 1998;

PCT WO 98/55669 (Naundorf et al.), dated December 10, 1998;

PCT WO 99/05895 (Naundorf et al.), dated February 4, 1999;

Patent Abstracts of Japan 04 280 458 (Hajime), dated October 6, 1992;

Patent Abstracts of Japan 05 251 455 (Sakae), dated September 28, 1993;

International Search Report, dated June 17, 1999;

Respectfully submitted.

For Applicants

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